



## **Schottky Barrier Rectifier**

Qualified per MIL-PRF-19500/553

Qualified Levels: JAN, JANTX, JANTXV and JANS

## **DESCRIPTION**

This schottky barrier diode provides low forward voltage and offers military grade qualifications for high-reliability applications. This rugged DO-203AA rectifier is applicable for freewheeling diodes, rectification in high-frequency, low-voltage inverters, and for polarity protection.



DO-203AA (DO-4) Package

Important: For the latest information, visit our website <a href="http://www.microsemi.com">http://www.microsemi.com</a>.

## **FEATURES**

- Internal solder bond construction.
- Hermetically sealed (welded).
- 600 Amps surge rating.
- JAN, JANTX, JANTXV and JANS qualifications are available per MIL-PRF-19500/553.
- RoHS compliant devices available by adding "e3" suffix (commercial grade only).

## **APPLICATIONS / BENEFITS**

- Metal and glass construction.
- Reverse energy tested.
- · Fast recovery.

## **MAXIMUM RATINGS** @ T<sub>A</sub> = +25 °C unless otherwise stated

Parameters/Test Conditions	Symbol	Value	Unit
Junction and Storage Temperature	$T_J$ and $T_{STG}$	-55 to +175	°C
Thermal Resistance Junction-to-Case	R <sub>OJC</sub>	2.0	°C/W
Reverse Voltage, Repetitive Peak and Working Peak Reverse Voltage (1)	$V_{RRM}$ and $V_{RWM}$	45	V
Reverse Voltage, Nonrepetitive Peak	$V_{RSM}$	54	V
Reverse Voltage (1)	$V_R$	45	V
Forward Surge Current @ 8.3 ms half-sine wave	I <sub>FSM</sub>	600	Α
Average Forward Current 50% duty cycle square wave @ $T_C = +125$ °C (2)	I <sub>FM</sub>	25	А
Average Rectified Output Current @ T <sub>C</sub> = +125 °C (3)	Io	22.5	Α
Solder Pad Temperature @ 10 s		260	°C

- **NOTES:** 1. Full rated  $V_{RRM}$  and  $V_{RWM}$  with 50% duty cycle is applicable over the range of  $T_C = -55$  °C to +165 °C for  $I_{FM} = 0$ . Full rated continuous  $V_R$  (dc) is applicable over the temperature range of  $T_C = -55$  to +155 °C. When  $V_R = 45$  V and  $T_C = +155$  °C, then  $T_J = 175$  °C.
  - 2. Average current with a 50 percent duty cycle square wave including reverse amplitude equal to the magnitude of full rated  $V_{RWM}$ . Derate linearly at 0.625 A/°C for  $T_C > +125$  °C.
  - Average current with an applied half-sine wave peak voltage value equal to the magnitude of full rated V<sub>RWM</sub>. For temperature-current derating curves, see <u>Figure 4</u>.

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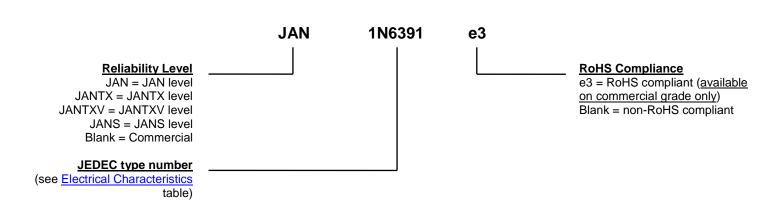
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### **MECHANICAL and PACKAGING**

- CASE: Industry standard DO-4, (DO-203AA), 7/16" hex, stud with 10-32 threads, welded, hermetically sealed metal and glass.
- TERMINALS: Tin-lead plated or RoHS compliant matte-tin plating (commercial grade only) on nickel.
- POLARITY: Cathode to stud.
- MOUNTING HARDWARE: Nut, flat steel washer and lock washer available upon request.
- WEIGHT: Approximately 7.5 grams.
- See Package Dimensions on last page.

## **PART NOMENCLATURE**



SYMBOLS & DEFINITIONS				
Symbol	Definition			
f	Frequency			
I <sub>FM</sub>	Forward Current: The current flowing from the external circuit into the anode terminal. Also see first page ratings and test conditions for I <sub>FM</sub> with 50% duty cycle square wave.			
I <sub>FSM</sub>	Surge Peak Forward Current: The forward current including all nonrepetitive transient currents but excluding all repetitive transients (ref JESD282-B).			
Io	Average Rectified Forward Current: The output current averaged over a full cycle with a 50 Hz or 60 Hz sine-wave input and a 180 degree conduction angle.			
$V_{FM}$	Maximum Forward Voltage			
$V_R$	Reverse Voltage: A positive dc cathode-anode voltage below the breakdown region.			
$V_{RRM}$	Repetitive Peak Reverse Voltage: The peak reverse voltage including all repetitive transient voltages but excluding all non-repetitive transient voltages.			
V <sub>RSM</sub>	Non-Repetitive Peak Inverse Voltage: The peak reverse voltage including all non-repetitive transient voltages but excluding all repetitive transient voltages.			
$V_{RWM}$	Working Peak Reverse Voltage: The peak voltage excluding all transient voltages (ref JESD282-B). Also sometimes known historically as PIV.			



## **ELECTRICAL CHARACTERISTICS**

Parameters / Test Conditions	Symbol	Min.	Max.	Тур.	Unit
Forward Voltage $I_{FM} = 50 \text{ A}, T_C = 25 \text{ °C *}$ $I_{FM} = 5 \text{ A}, T_C = 25 \text{ °C *}$	V <sub>FM</sub>		0.68 0.50		V
Reverse Current Leakage $V_{RM}=45~V,~T_J=25~^{\circ}C$ $V_{RM}=45~V,~T_J=175~^{\circ}C~^{*}$ $V_{RM}=45~V,~T_J=125~^{\circ}C~^{*}$ $V_{RM}=45~V,~T_C=-55~^{\circ}C~^{*}$	I <sub>RM</sub>		1.5 220 40 1.5		mA
Junction Capacitance $V_R = 5 \text{ V}, f = 1 \text{ MHz}, 100 \text{ KHz} \le f \le 1 \text{ MHz}$	Сл		2000		pF

<sup>\*</sup>Pulse test: pulse width 300  $\mu sec$ , duty cycle 2%



## **GRAPHS**

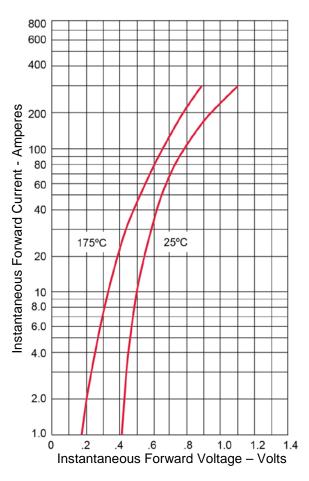


FIGURE 1
Typical Forward Characteristics

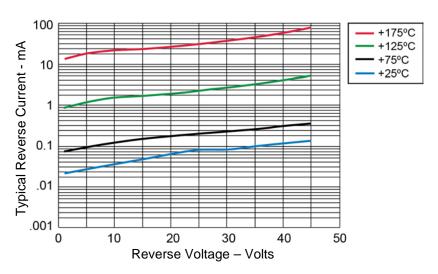


FIGURE 2
Typical Reverse Characteristics



## **GRAPHS**

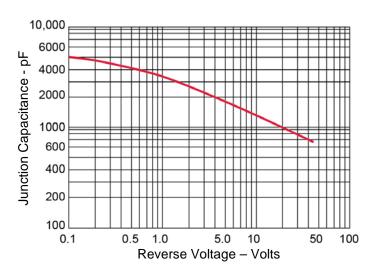


FIGURE 3
Typical Junction Capacitance

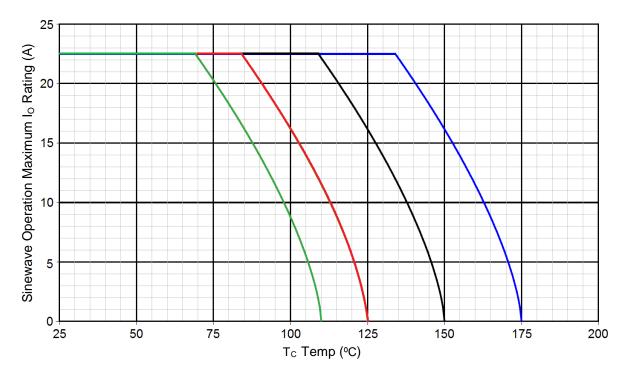


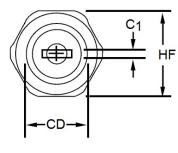
FIGURE 4

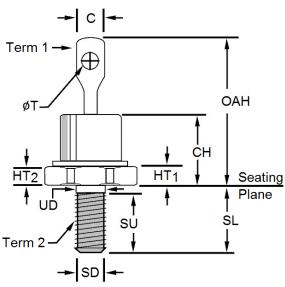
<u>Temperature – Current Derating Curve</u>

(Derate design curve constrained by the maximum rated junction temperature (TJ ≤ 175C) and current rating specified.)



## **PACKAGE DIMENSIONS**





	Dimensions				
Ltr	Inch		Millimeters		Notes
	Min	Max	Min	Max	
С		.250		6.35	5
C <sub>1</sub>	0.018	0.65	0.46	1.65	5
CD	0.265	0.424	6.73	10.77	6
CH	0.300	0.405	7.62	10.29	
HF	0.403	0.437	10.24	11.1	6
HT <sub>1</sub>	0.075	0.175	1.91	4.45	7
HT <sub>2</sub>	0.060	-	1.53	-	7
OAH	0.600	0.800	15.24	20.32	
SD					2
SL	0.422	0.453	10.72	11.51	
SU		0.078		1.98	8
UD	0.163	0.189	4.14	4.80	
ΦТ	0.060	0.095	1.52	2.41	

### NOTES:

- 1. Dimensions are in inches. Millimeters are given for information only.
- 2. See "mechanical and packaging" for the polarity of the terminals.
- 3. Threads shall be 10–32 UNF–2A in accordance with FED–STD–H28. Maximum pitch diameter (SD) of plated threads shall be basic pitch diameter 0.1697 inch (4.31 mm).
- 4. Device shall not be damaged by a torque of 15 inch–pounds applied to a 10–32 UNF–2B nut assembled on thread.
- 5. The angular orientation and peripheral configuration of terminal 1 is undefined, however, the major surfaces over dimension C and C1 shall be flat.
- 6. Dimension CD cannot exceed dimension HF.
- 7. A chamfer or undercut on one or both ends of the hex portion is optional; minimum base diameter at seating plane 0.403 inch (10.24 mm).
- 8. Length of incomplete or undercut threads UD.
- 9. In accordance with ASME Y14.5M, diameters are equivalent to Φx symbology.

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